

Research Article

Responsivity Dependent Anodization Current Density of Nanoporous Silicon Based MSM Photodetector

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Achieving a cheap and ultrafast metal-semiconductor-metal (MSM) photodetector (PD) for very high-speed communications is ever-demanding. We report the influence of anodization current density variation on the response of nanoporous silicon (NPSi) based MSM PD with platinum (Pt) contact electrodes. Such NPSi samples are grown from n-type Si (100) wafer using photoelectrochemical etching with three different anodization current densities. FESEM images of as-prepared samples revealed the existence of discrete pores with spherical and square-like shapes. XRD pattern displayed the growth of nanocrystals with (311) lattice orientation. The nanocrystallite sizes obtained using Scherrer formula are found to be between 20.8 nm and 28.6 nm. The observed rectifying behavior in the *I-V* characteristics is ascribed to the Pt/PSi/n-Si Schottky barrier formation, where the barrier height at the Pt/PSi interface is estimated to be 0.69 eV. Furthermore, this Pt/PSi/Pt MSM PD achieved maximum responsivity of 0.17 A/W and quantum efficiency as much as 39.3%. The photoresponse of this NPSi based MSM PD demonstrated excellent repeatability, fast response, and enhanced saturation current with increasing anodization current density.

1. Introduction

Canham's [1] discovery on the room temperature visible photoluminescence (PL) from porous silicon (PSi) generated intense research interests towards the synthesis and characterization of Si nanostructures (NSs) in general and nanoporous silicon (NPSi) in particular. These spectra of research activities are mainly targeted to achieve Si nanomaterials with desired band gap useful for efficient optoelectronic applications [2–4]. Over the years, various promising electroluminescent devices are fabricated [5, 6]. Nanosilicon research is triggered not only because of technological implication but also to unravel the fundamental mechanism, socalled quantum confinement effect, which is responsible for the energy band gap enhancement [7, 8]. Porous silicon (PSi) exhibits several notable attributes including direct and wide modulated energy band gap, high resistance, large surfaceto-volume ratio, and identical single-crystalline structure as

bulk Si. These properties are beneficial for making photodetectors [9, 10].

Earlier, different types of solid-state PDs are fabricated such as the p-n junction, MSM structure, and Schottky diodes. Among all these, MSM PDs received special attention due to their easy fabrication and integration flexibility. Planar PSi MSM PDs are already fabricated without rapid thermal oxidation (RTO) treatment [10, 11], where the finger contacts are made using a micromachined Si mask. Tsai et al. [12] fabricated the Si p-n junction PD with a subsequent RTO PSi antireflection cap layer. Lee et al. [13, 14] claimed that the RTO and Rapid Thermal Annealing (RTA) treatments to PSi MSM PD can enhance the photoresponsivity and reduce the dark current significantly. This reduction in the dark current is attributed to the annealing assisted formation of an oxide between the metal and semiconductor layer. Creation of high-performance MSM PDs requires a large Schottky barrier height at the metal semiconductor interface, leading to a small leakage current and high breakdown voltage. This improves the responsiveness in terms of photocurrent to dark current ratio. Generally, to achieve a large Schottky barrier height on Si and PSi, one selects the metals with high work functions such as gold (Au), platinum (Pt), palladium (Pd), and nickel (Ni). However, most of these outperforming metals are unstable at high temperature due to severe interdiffusion at the metalsemiconductor interface [15]. Platinum, being an interesting functional metal with excellent thermal and chemical properties, is extensively used as a stable Schottky contact in wide band gap InGaN [16].

Considering the prospect of NPSi in MSM PD, we fabricated a Pt/PSi/Pt PD and determined its photoresponse as well as *I*-*V* characteristics. Low cost nanocrystalline PSi samples are synthesized in the absence of thermal oxidation treatment. The effects of variable anodization current density on the morphology, structure, and PL properties of such NPSi structures are evaluated.

2. Experimental Methods

Phosphorus doped crystalline n-type Si (100) substrates (resistivity, ~1 to $10 \Omega \cdot cm$) are etched via photoelectrochemical reaction in the presence of continuous illumination at varying anodization current density to grow NPSi. At first, these Si substrates are cleaned via wet chemical etching (RCA cleaning method). Then, two-electrode setup is applied including Si as anode and Pt mesh as cathode. Next, these crystalline Si wafers are anodized in a 1:4 solution (48% HF to ethanol) for 15 min at changing anodization current density such as 20, 25, and 35 mA/cm² under constant illumination (halogen lamp with 50 W power placed at a distance of 15 cm from the sample). Finally, the MSM diode is fabricated via samples metallization, where finger-shaped Pt electrodes (metal contacts of 200 nm thickness) are deposited on the top of NPSi specimen using A500 Edward radio frequency magnetron sputtering system. In the present study, Pt is used for Schottky contact due to its high value of work function. The structure of MSM photodetector is comprised of a pair of interdigitated Schottky contacts (electrodes), where each electrode has four fingers having width of 230 μ m and spacing of 400 μ m and length of each electrode is about 3.3 mm. The two sets of finger electrodes are identical. The percentage of covered area (Schottky contact) is 1.5×10^{-4} cm² and the irradiated area of the device is 0.784 cm^2 . The morphology of the NPSi samples is analyzed using field emission scanning electron microscopy (FESEM, JSM-7600F). Samples crystallinity is verified using X-ray diffraction (PANalytical X'Pert PRO). Raman measurement is performed (WITec) to examine the vibrational modes. PL spectra are recorded using a Perkin-Elmer LS-55 spectrophotometer. The electrical properties of the developed MSM PD are examined via Keithley Model 4200-SCS instrument. The photoelectric response is evaluated using a 460 nm wavelength pulsed LED operated at the intensity of 7 W/cm^2 .

3. Results and Discussion

3.1. Morphological and Structural Characterization of NPSi. FESEM images in Figure 1 display the anodization current density dependent morphological evolution of the grown PSi samples. Figures 1(a)–1(c) illustrate the top views of the three samples and the corresponding cross-sectional views are presented in Figures 1(d)-1(f). They showed regular columns of Si nanocrystal with pores (hole) in between. It is clear that the sample morphology is highly sensitive to the change in etching current. Figure 1(a) revealed nonuniform pores with decrease in the pore density. The cross-sectional view (Figure 1(d)) showed the occurrence of nonparallel and partially cracked silicon walls, which caused narrow and asymmetrical holes between them. Sample grown at 25 mA/cm² anodization current density (Figure 1(b)) displayed substantially wider pores, which are irregular across the entire surface. The cross-sectional view (Figure 1(e)) indicated an increase in the thicknesses up to $37.1\,\mu\text{m}$. Sample grown at 35 mA/cm² anodization current density (Figure 1(c)) exhibited highly porous nature with columnar structure, which is uniform across the entire surface. The cross-sectional view (Figure 1(f)) demonstrates that the silicon walls can be distinguished from the sharp pin-shaped holes with lengths of up to $48 \,\mu m$ inside the silicon substrate. Furthermore, an increase in the anodization current density is found to reduce the size of columns of Si nanocrystal.

Figure 2 illustrates the XRD patterns of three PSi samples and the inset signifies the corresponding bulk Si pattern. The occurrence of sharp and dominant peak at 56.13° corresponds to the growth along (311) lattice plane. In addition, a weak peak located at 47.5° corresponding to the diffraction peaks of Si from (220) is observed. All the prepared samples revealed prominent growth peak along (311) orientation at 56.14° (grown at 20 mA/cm^2), 56.15° (grown at 25 mA/cm^2), and 56.17° (grown at 35 mA/cm^2). This peak clearly verified the existence of nanocrystals in the PSi samples. Scherrer formula [17] is used to calculate the crystallite sizes, which are found to be 28.6 nm, 26.8 nm, and 20.8 nm for samples grown at current density of 20 mA/cm², 25 mA/cm², and 35 mA/cm², respectively. The broadening of XRD peak is attributed to the effect of size confinement [12]. The XRD results are in agreement with the FESEM analyses.

Figure 3 shows the room temperature Raman spectra of all the samples. Samples grown at anodization current density of 20, 25, and 35 mA/cm^2 displayed significant Raman peaks centered at 516 cm^{-1} , 514 cm^{-1} , and 511 cm^{-1} , respectively. These peaks are allocated to the Si–Si optical phonon mode for NPSi structures. In crystalline bulk Si, due to the conservation of quasi momentum, the optical phonon peak appears at 520.2 cm^{-1} . A decrease in the nanocrystallite size at higher anodization current shifted the optical phonon peak towards the lower frequency which is in conformity with the XRD and FESEM results. Moreover, these peaks are broadened and appeared to be more intense [18]. The observed shift in the Raman peak is attributed to the reduction in the phonon energy aroused from the disturbances in the NPSi lattice structure.

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FIGURE 1: FESEM images of the NPSi obtained at variance anodization current density: top view of (a) 20 mA/cm^2 , (b) 25 mA/cm^2 , and (c) 35 mA/cm^2 . Cross section of (d) 20 mA/cm^2 , (e) 25 mA/cm^2 , and (f) 35 mA/cm^2 .





FIGURE 2: XRD patterns of NPSi samples grown at various anodization current densities: 20 mA/cm², 25 mA/cm², and 35 mA/cm².

FIGURE 3: Raman spectra of NPSi synthesized at different anodization current density, (a) 20 mA/cm^2 , (b) 25 mA/cm^2 , and (c) 35 mA/cm^2 , and bulk Si.

3.2. Photoluminescence Spectra. Figure 4 depicts the room temperature PL spectra of samples etched at different current densities. The observed blue shift in the PL peak with the increase of the anodization current originated from quantum

confinement effect signified an enhancement in the energy band gap of as much as 2.06 eV. A reduction in the FWHM for the peak is evidenced with the increase in the anodization current from 20 to 35 mA/cm^2 . Furthermore, the increase



FIGURE 4: PL spectra of PSi samples at room temperature for anodization current of 20 mA/cm^2 , 25 mA/cm^2 , and 35 mA/cm^2 .

in PL intensity with the increase of anodization current is due to the enhanced recombination probability of the carriers in the strongly confined nanostructure, where the nature of the band gap is transformed from indirect one to quasidirect one [17]. These observations related to PL peak shift, narrowing of FWHM, and increase in the peak intensity are in good agreement with other findings [19, 20]. The observed Sband luminescence is reported to occur within 400–800 nm [19]. It is asserted that the increase in samples porosity and enhancement in the PL intensity and the blue shift with increasing anodization current are strongly correlated. Thus, the variation in the anodization current and etching time duration strongly affected the PL properties of synthesized NPSi [19–21].

3.3. Current-Voltage Characteristics. Figure 5 demonstrates the I-V characteristics of Pt/NPSi planer system under ambient light illumination as a function of varying anodization current. When a metal and a semiconductor with no surface states are brought in contact with each other at equilibrium, their Fermi levels get aligned. This alignment of Fermi levels is due to the charge motion from the higher energy side towards the lower energy side, resulting in the creation of a depletion region in the semiconductor and a barrier on the interface [22]. So, the observed rectifying behavior of the planer system is attributed to the formation of Schottky barrier at Pt/PSi interface, which controls the current conduction as well as the capacitance. The forward bias characteristics of the samples are controlled by the resistance of PSi layer, which is responsible for the reduction of current flow with increasing anodization current [20]. Increased porosity with increase in the anodization current leads to the formation of regular columns (Si nanocrystal) and pores (hole). Thus, the



FIGURE 5: *I-V* characteristics of Pt contact created above the NPSi samples prepared at anodization current at 20 mA/cm^2 , 25 mA/cm^2 , and 35 mA/cm^2 under ambient light illumination.

surface area becomes larger and contains a high density of donor-like surface state acting as carriers trap, thereby reducing the current flow in the porous PSi layer. Generally, the sensitivity of the MSM PDs gets enhanced with the increase of bias voltage. However, in the present case, the current is found to be nearly constant to the light at smaller bias voltages ($V_{\text{bias}} < 0.5 \text{ V}$). This observation is attributed to the Pt/PSi/n-Si space charge region mediated restricted current flow in the MSM structure. However, in the higher voltage zone, the PSi absorbs light to produce more e-h pairs within the space charge region. The existence of the electrical field within the space charge region resulting from an applied high bias voltage led to the separation of the charge carriers, which created an upward surge in thermionic emission and carrier velocity. Consequently, the current is exponentially increased with the applied voltage which exceeded the potential barrier. The bias voltage provided sufficient energy to the electron to break the barrier height and generated strong diffusion current [11, 20] by drifting the holes and the electrons to the positive and negative sides, respectively. This mechanism is responsible for the generation of the photocurrent in the exterior contact. Besides, the inflow of electrons within the circuit transformed the optical signals to electrical signals; thus the PD is successfully implemented.

This result clearly demonstrates the influence of anodization current densities on the *I*-V characteristics of MSM devices, in which the sample prepared at 35 mA/cm² reveals a very low current in comparison to other samples. This observation is attributed to the high resistivity and Schottky barrier height of the proposed photodetector. Meanwhile, the sample prepared at 25 mA/cm^2 displayed the highest leakage current which may arise from other current transport mechanisms. In fact, if the thermionic emission over the barrier is neglected, then the current transport mechanism may include the direct tunneling of carriers [16]. Meanwhile, the sample prepared at 35 mA/cm^2 showed lowest value of



FIGURE 6: Repetitive switching of the Pt/NPSi photodetectors under blue light (460 nm) at 2 V applied across two electrodes of (a) 20 mA/cm², (b) 25 mA/cm², and (c) 35 mA/cm².

leakage current, indicating that the electrical properties are improved.

Fundamentally, the value of Schottky barrier height and the ideality factor decide the outperforming nature of electronic devices. Structurally, MSM consists essentially of two Schottky contacts connected back-to-back with one another. The arrangement for the contacts allows for reverse bias and forward bias under a biasing voltage from -5 V to +5 V. Following the thermionic emission-diffusion theory, the expression for the Schottky barrier height (Φ_B) and the ideality factor (*n*) is written as [11, 23]

$$I = I_0 \exp\left[\frac{qv}{nK_BT}\right],$$

$$I_0 = A^* A T^2 \exp\left[\frac{-q\Phi_B}{K_BT}\right],$$
(1)

where I_0 is the saturation anodization current density, T is the temperature, K_B is Boltzmann constant, A^* is the effective Richardson coefficient, A is the area of the Schottky contact $(1.5 \times 10^{-4} \text{ cm}^2)$, and q is the electronic charge.

The intercept of $\ln I \sim V$ curve is used to calculate the value of Φ_B . Table 1 summarizes the estimated values of Φ_B , I_0 , and

n for all the samples. The alteration in Φ_B values at different current densities is attributed to the surface roughening, which played a significant role in the interface between the porous Si surface and the metal, leading to the enhancement of the electrical properties [24]. The high porosity at large anodization current density is ascribed to responsibility for the increase of Φ_B , which led the Fermi level to shift towards the valence band and decrease in the leakage current [24]. These proportionately large values of the ideality factor may be correlated to the higher density of interface states [25]. It is acknowledged that the presence of two heterojunctions in samples such as the one in the substrate-porous Si interface and the other within the porous Si and Pt is responsible for the enhancement of n [26]. In addition, the occurrence of inhomogeneous barrier height can make n large as reported earlier [20].

3.4. Photocurrent and Light Responsivity. Repeatability of the fabricated PSi MSM PDs is examined by measuring the photoresponse. The dynamic responsivity time is measured by illuminating the PDs with chopped blue light (460 nm at 7 W/cm^2) at bias voltage of 2 V. Figure 6 shows the repetitive switching of the blue light for the fabricated PDs at 2 V

TABLE 1: Etching current density dependent Schottky barrier height, ideality factor, and saturation current of Pt/NPSi system.

Anodization current density (mA/cm ²)	$\Phi_B (eV)$	п	Saturation current (A)
20	0.67	4.6	1.2×10^{-7}
25	0.68	5.1	1.9×10^{-7}
35	0.69	4.1	2.5×10^{-7}

for the NPSi samples grown at anodization current density. The photocurrent is found to be stable and repeatable in each on/off period. The response time at various anodization current of 20, 25, and 35 mA/cm^2 is achieved to be 35 ms, 30 ms, and 20 ms, respectively, whereas the recovery time is discerned to be 40 ms, 44 ms, and 37 ms, respectively.

The response time and recovery time of the PSi, especially for the sample prepared at 35 mA/cm^2 , revealed the shortest value as compared to those achieved by others [27–30]. The maximum response that is obtained at high anodization current (high porosity) is attributed to the defects-free state, good quality, and big photoactive surface areas of the samples. The fast response is associated with the short transit time of photogenerated carriers with long lifetime [29], whereas the slow response time corresponded to the presence of grain boundaries and the oxygen adsorption at the surface [31], as verified by other findings [20].

The light responsivity (*R*) is the important parameter that sets the photovoltaic sensitivity of devices, which is defined by the photocurrent (I_{ph}) produced for every unit power of incident light (P_{inc}) on the active area (*A*) of the PDs and expressed as [30]

$$R = \frac{I_{\rm ph}(A)}{P_{\rm inc}(W)} = \frac{I_{\rm ph}(A)}{E(W/\rm{cm}^2)A(\rm{cm}^2)},$$
 (2)

where E is the energy of Xenon radiation source measured using standard photometer.

Figure 7 illustrates the anodization current dependent room temperature photoresponse of Pt/PSi/n-Si PD. The responsivity spectra are comprised of two main visible peaks centered at 530 nm and 765 nm. The light responsivity of the PD devices is measured in the wavelength range of 300– 900 nm under 5 V bias voltages. The overall responsivity of PSi is found to improve with increasing anodization current density. The measured values of responsivity are 0.053, 0.12, and 0.17 A/W at 530 nm for anodization current densities of 20, 25, and 35 mA/cm², respectively. This alteration in the light responsivity is attributed to the change in the thickness of the active area and the contact coverage of samples [20]. The maximum response is attained for thick sample with high porosity.

The value of peak responsivity of n-type PSi based MSM PD fabricated by photoelectrochemical etching is 0.17 A/W at the wavelength of 530 nm. This is much higher (170 times) than the one reported for PSi MSM structures [32, 33] for different p-type PSi fabrication via electrochemical etching. The observed intense peak at 530 nm originated from the upper



FIGURE 7: Photoresponse of Pt/NPSi as a function of the wavelength for MSM device prepared at anodization current of 20 mA/cm², 25 mA/cm², and 35 mA/cm².

platinum contacts, which is also observed in Au-Si device [34]. The relatively weaker peak at 765 nm emerged from PS/Si junction [33]. The enhancement of light responsiveness at lower wavelength is due to the increase in photocurrent as shown in (2), where an increase in the porosity at higher anodization current generated large number of e-h pairs in the depletion region. This is expected because the penetration depth gets reduced with the wavelength, thereby lowering the photons absorption in the Si substrate and simultaneously enhancing the depletion region. Thus, the number of e-h pairs generated in the depletion region is increased with the reduction of wavelength. Further observation revealed that the light responsivity is reduced sharply at smaller wavelength (blue and near UV). This is confirmed by the absorption of photons in the PSi film, negating its arrival at the depletion region [9], which is consistent with other reports [35].

The performance of the developed photosensitive device is evaluated in terms of quantum efficiency (η), which is correlated with the number of electron-hole pairs that are excited by the absorbed photons and given by [30]

$$\eta = R \times \frac{hc}{q\lambda},\tag{3}$$

where λ is the wavelength of incident light, *h* is the Plank constant, and *c* is the velocity of light.

The quantum efficiency of the designed PSi photodiodes is discerned to be 12.3%, 28.3%, and 39.5% for the current densities of 20, 25, and 35 mA/cm², respectively. This observation is similar to the one reported in Ag/PSi Schottky PDs using alternative current to anodization PSi [20]. It is found that the responsivity of such MSM photodiode can reach 0.5 A/W. The occurrence of large responsivity with quantum efficiency of as much as 99.5% clearly indicated the existence of internal gain in this photodiode. It is acknowledged that the large responsivity and the observed internal gain are originated from the defects in their PSi film or from metal/semiconductor interfaces [20]. Besides, the spectral evolution as a function of etching current density appeared to be identical to those of spectral responsivity.

4. Conclusions

The effects of changing anodization current densities on the performance of NPSi based MSM PD are examined. These PDs are successfully fabricated by metallization of NPSi and their photoresponse in the visible region is evaluated. It is demonstrated that the anodization current density significantly controlled the pore density and the spectral responsivity. The synthesized NPSi samples are of good quality. They exhibited strong PL peak accompanied by a large blue shift, which indicated the existence of the high regularity and large porosity of this surface. Nature of this surface is established to be responsible for decreasing the Si crystallite size at higher anodization current density. For this fabricated PDs, we achieved good stability over time, great responsivity, fast response, and quick recovery time. It is asserted that the efficiency of the proposed PDs can be further improved by controlling the etching current density. Our systematic method of sample preparation, PDs fabrication, and characterization may constitute a basis for the development of NPSi based MSM PDs.

Competing Interests

The authors declare that they have no competing interests.

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